DISCRETE SEMICONDUCTORS



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Philips Semiconductors

## **BAS70W** series

### **FEATURES**

- Low forward voltage
- High breakdown voltage
- · Guard ring protected
- Very small SMD package
- · Low capacitance.

### **APPLICATIONS**

- Ultra high-speed switching
- Voltage clamping
- Protection circuits
- · Blocking diodes.

#### DESCRIPTION

Planar Schottky barrier diodes. Single diodes (BAS70W) and double diodes with different pinning (BAS70-04W; -05W; -06W) are available.

The diodes are encapsulated in a SOT323 very small plastic SMD package.

#### MARKING

| TYPE NUMBER | MARKING<br>CODE |  |
|-------------|-----------------|--|
| BAS70W      | 73-             |  |
| BAS70-04W   | 74-             |  |
| BAS70-05W   | 75-             |  |
| BAS70-06W   | 76-             |  |

### PINNING





BAS70W single diode Fig.2 configuration (symbol).

n.c MI C 257



configuration (symbol).

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#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL           | PARAMETER                           | CONDITIONS                            | MIN. | MAX. | UNIT |
|------------------|-------------------------------------|---------------------------------------|------|------|------|
| Per diode        | Per diode                           |                                       |      |      |      |
| V <sub>R</sub>   | continuous reverse voltage          |                                       | -    | 70   | V    |
| l <sub>F</sub>   | continuous forward current          |                                       | -    | 70   | mA   |
| I <sub>FRM</sub> | repetitive peak forward current     | $t_p \le 1 \text{ s}; \delta \le 0.5$ | _    | 70   | mA   |
| I <sub>FSM</sub> | non-repetitive peak forward current | t <sub>p</sub> < 10 ms                | _    | 100  | mA   |
| T <sub>stg</sub> | storage temperature                 |                                       | -65  | +150 | °C   |
| Tj               | junction temperature                |                                       | -    | 150  | °C   |
| T <sub>amb</sub> | operating ambient temperature       |                                       | -65  | +150 | °C   |

#### **ELECTRICAL CHARACTERISTICS**

 $T_{amb} = 25 \ ^{\circ}C$  unless otherwise specified.

| SYMBOL         | PARAMETER                                  | CONDITIONS  | MAX. | UNIT |
|----------------|--|---|------|------|
| Per diode      |  |   | •    | -    |
| V <sub>F</sub> | forward voltage                            | see Fig.6   |      |      |
|                |  | I <sub>F</sub> = 1 mA                                     | 410  | mV   |
|                |  | I <sub>F</sub> = 10 mA                                    | 750  | mV   |
|                |  | I <sub>F</sub> = 15 mA                                    | 1    | V    |
| I <sub>R</sub> | reverse current                            | $V_R = 50$ V; note 1; see Fig.7                           | 100  | nA   |
|                |  | V <sub>R</sub> = 70 V; note 1; see Fig.7                  | 10   | μA   |
| τ              | charge carrier life time (Krakauer method) | I <sub>F</sub> = 5 mA                                     | 100  | ps   |
| C <sub>d</sub> | diode capacitance                          | $f = 1 \text{ MHz}; V_R = 0 \text{ V}; \text{ see Fig.9}$ | 2    | pF   |

#### Note

1. Pulsed test:  $t_p = 300 \ \mu s$ ;  $\delta = 0.02$ .

#### THERMAL CHARACTERISTICS

| SYMBOL              | PARAMETER                                   | CONDITIONS | VALUE | UNIT |
|---------------------|---|------------|-------|------|
| R <sub>th j-a</sub> | thermal resistance from junction to ambient | note 1     | 625   | K/W  |

#### Note

1. Refer to SOT323 standard mounting conditions.

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### **GRAPHICAL DATA**



## **BAS70W** series

#### PACKAGE OUTLINE



#### DEFINITIONS

| Data sheet status   |  |  |  |
|---|--|--|--|
| Objective specification                                       | This data sheet contains target or goal specifications for product development.  |  |  |
| Preliminary specification                                     | This data sheet contains preliminary data; supplementary data may be published later.  |  |  |
| Product specification   | This data sheet contains final product specifications.   |  |  |
| Limiting values   |  |  |  |
| more of the limiting values i<br>of the device at these or at | accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or<br>may cause permanent damage to the device. These are stress ratings only and operation<br>any other conditions above those given in the Characteristics sections of the specification<br>limiting values for extended periods may affect device reliability. |  |  |
| Application information                                       |  |  |  |
|   |  |  |  |

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.